502796821 05/06/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TETSUO INAOKA	04/08/2014
DAICHI OHARA	04/02/2014
TOSHIAKI OHASHI	04/14/2014

RECEIVING PARTY DATA

Name:	KANEKA CORPORATION	
Street Address:	3-18, NAKANOSHIMA 2-CHOME, KITA-KU	
City:	OSAKA-SHI, OSAKA	
State/Country:	JAPAN	
Postal Code:	530-8288	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14356307

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	10873.2596USWO	
NAME OF SUBMITTER:	DOUGLAS P. MUELLER	
SIGNATURE:	/Douglas P. Mueller/	
DATE SIGNED:	05/06/2014	

Total Attachments: 2

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> **PATENT REEL: 032829 FRAME: 0638** 502796821

ASSIGNMENT OF PATENT APPLICATION

WHEREAS,

1. <u>Tetsuo INAOKA</u> residing at c/o KANEKA CORPORATION, 1-8, <u>Takasagocho Miyamaecho</u>, <u>Takasago-shi</u>, <u>Hyogo 676-8688</u>, <u>JAPAN</u> and a citizen of <u>Japan</u>
2. <u>Daichi OHARA</u> residing at c/o KANEKA CORPORATION, 1-8, <u>Takasagocho Miyamaecho</u>, <u>Takasago-shi</u>, <u>Hyogo 676-8688</u>, <u>JAPAN</u> and a citizen of <u>Japan</u>
3. <u>Toshiaki OHASHI</u> residing at c/o KANEKA CORPORATION, 1-8, <u>Takasagocho Miyamaecho</u>, <u>Takasago-shi</u>, <u>Hyogo 676-8688</u>, <u>JAPAN</u> and a citizen of Japan

(hereinafter called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States for this invention which was filed on , entitled METHOD FOR PRODUCING CHLORINATED VINYL CHLORIDE RESIN, and which has been given application serial number ;

and

WHEREAS <u>KANEKA CORPORATION</u> (hereinafter "ASSIGNEE") a corporation organized under the laws of <u>Japan</u> and having an office and place of business at <u>3-18</u>, <u>Nakanoshima 2-chome</u>, <u>Kita-ku</u>, <u>Osaka-shi</u>, <u>Osaka 530-8288</u>, <u>JAPAN</u> wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign, and transfer to the ASSIGNEE, its successors, legal representative and assigns, the entire right, title and interest for the United States in and to the invention disclosed in said application, and in and to said application, as well as to all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said invention to the ASSIGNEE of the entire right, title and interest in and to the same, in accordance with the terms of this instrument.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to the UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, it successors or assigns, the entire right, title and interest in and to the

1

said invention, patent applications, Letters Patent, rights, titles, benefits, privileges, and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

4/8/2014
Date

April 2 2014
Date Itur Iracka Signature: Tetsuo INAOKA Dalchi Ohara Signature: Daichi OHARA 4/14/2014 Date

Toshick, Chashi Signature: Toshiaki OHASHI